

Multilayer Ceramic Chip Capacitors

CKCM25C0G1H101K060AA



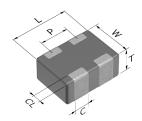






TDK item description CKCM25C0G1H101KT****

Applications	Commercial Grade	
Feature	2-Array 2 in 1 Array	
Series	CKCM25	
	↑ Obsolete	
Status	Discontinue Issue Date : Apr.28, 2018	
Status	Last Purchase Order Date : Oct.31, 2018	
	Last Shipment Date : Mar.31, 2019	



	Size	
Length(L)	1.37mm ±0.15mm	
Width(W)	1.00mm ±0.15mm	
Thickness(T)	0.60mm ±0.10mm	
Terminal Width(C)	0.36mm Nom.	
Terminal Spacing(P)	0.64mm Nom.	
Recommended Land Pattern (PA)	0.45mm to 0.55mm	
Recommended Land Pattern (PB)	0.45mm to 0.55mm	
Recommended Land Pattern (PC)	0.31mm to 0.41mm	
Recommended Land Pattern (PP)	0.59mm to 0.69mm	

Electrical Characteristics		
Capacitance	100pF ±10%	
Rated Voltage	50VDC	
Temperature Characteristic	COG(0±30ppm/°C)	
Q (Min.)	1000	
Insulation Resistance (Min.)	10000ΜΩ	

Other	
Soldering Method	Reflow
AEC-Q200	No
Packing	Punched (Paper)Taping [180mm Reel]
Package Quantity	4000pcs

[!] Images are for reference only and show exemplary products.

[!] This PDF document was created based on the data listed on the TDK Corporation website.

[!] All specifications are subject to change without notice.

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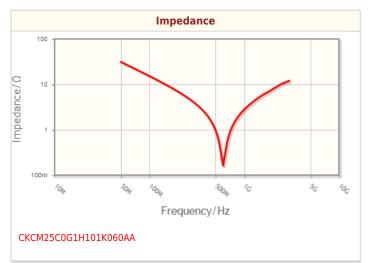


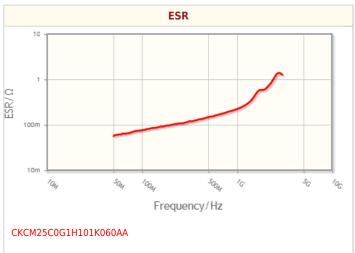


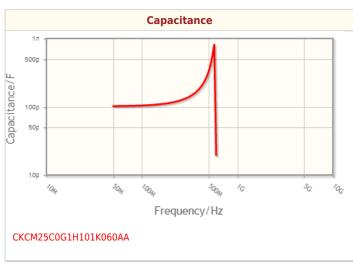


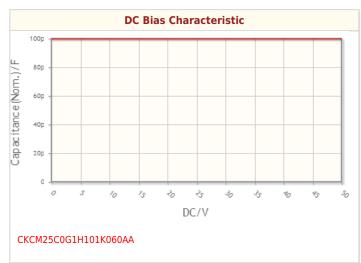


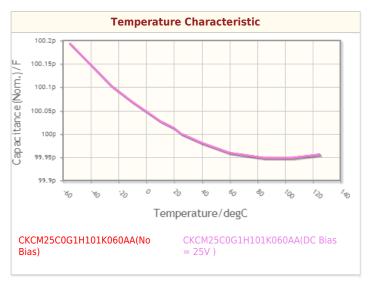
Characteristic Graphs(This is reference data, and does not guarantee the products characteristics.)











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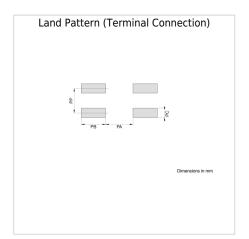








Associated Images



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